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STGW40NC60W

40 A - 600 V - ultra fast IGBT

Features

- Low C_{RES} / C_{IES} ratio (no cross conduction susceptibility)
- High frequency operation

Applications

- High frequency inverters, UPS
- Motor drivers
- HF, SMPS and PFC in both hard switch and resonant topologies
- Welding
- Induction heating

Description

This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trada-off between switching performance and low on-state Josolete Pro behavior.

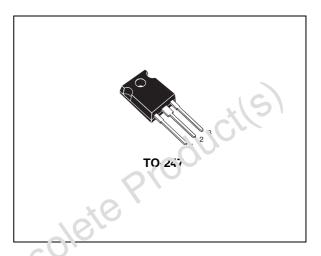


Figure 1.



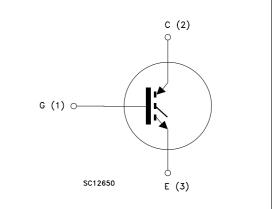


Table 1	Device	summary
I GOIO I	001100	ounnury

Order code	Marking	Package	Packaging
STGW40NC60W	GW40NC60W	TO-247	Tube

Contents

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	Obsolete .	
	Product(S)	
Obe	Electrical ratings	



Electrical ratings 1

Table 2.	Absolute	maximum	ratings
	Absolute	maximum	runngo

Symbol	Parameter	Value	Unit				
V _{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600	V				
I _C ⁽¹⁾	Collector current (continuous) at 25 °C	70	А				
I _C ⁽¹⁾	Collector current (continuous) at 100 °C	40	А				
I _{CL} ⁽²⁾	Turn-off latching current	230	А				
I _{CP} ⁽³⁾	Pulsed collector current	230	A				
V_{GE}	Gate-emitter voltage	±20	V				
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	250	W				
Тj	Operating junction temperature	- 55 to 150	°C				
1. Calculated according to the iterative formula:							
$I_{C}(T_{C}) = \frac{1}{R_{THJ}}$	$\frac{T_{JMAX} - T_{C}}{-C \times V_{CESAT(MAX)} (T_{C}, I_{C})}$	ste					
Volamn –	$80\%(V_{0,70})$ Ti = 150 °C B ₀ = 10 O V_{0,77} 15 V						

$$I_{C}(T_{C}) = \frac{T_{JMAX} - T_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

2. Vclamp = 80%(V_{CES}), Tj = 150 °C, R_G = 10 Ω , V_{GE⁼} 15 ½

3. Pulse width limited by max. junction temperature allowed

Thermal resistance Table 3.

	Symbol	Parameter	Value	Unit
	R _{thj-case}	Thermai redistance junction-case max	0.5	°C/W
	R _{thj-amb}	Themal resistance junction-ambient max	50	°C/W
Obsole	jeri			

Electrical characteristics 2

(T_{CASE}=25 °C unless otherwise specified)

Table 4.	Static
i able 4.	Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage ($V_{GE} = 0$)	I _C = 1 mA	600			v
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _C =125 °C		2.1 1.9	2.5	v v
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 250 \mu A$	3.75	X	5.75	V
I _{CES}	Collector-emitter cut-off current (V _{GE} = 0)	V _{GE} = 600 V V _{GE} = 600 V, T _C =125 °C	6	20	500 5	μA mA
I _{GES}	Gate-emitter cut-off current (V _{CE} = 0)	V _{GE} = ± 20 V			±100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15 V_{1,2} = 30 V$		20		S

Table 5. Dynamic

	Table 5. Symbol	Dynamic Parameter	Test conditions	Min.	Тур.	Max.	Unit
	C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0		2900 298 59		pF pF pF
	Q _g Q _{ge} ସ୍ _{jc}	Tctal gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, \text{ I}_{C} = 30 \text{ A},$ $V_{GE} = 15 \text{ V}$ (see Figure 17)		126 16 46		nC nC nC
Obsole	,		•				

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V}$ <i>(see Figure 16)</i>		33 12 2600		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_C = 125 \text{ °C}$ <i>(see Figure 16)</i>		32 14 2300		ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ <i>(see Figure 16)</i>		26 168 C6	6	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A},$ $R_{GE}=10 \Omega, V_{GE} = 15 \text{ V}$ $T_C=125 \text{ °C} (see Figure 16)$	0	54 213 67		ns ns ns

Table 6. Switching on/off (inductive load)

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching lossອร Total switching losses	V_{CC} = 390 V, I _C = 30 A R _G = 10 Ω, V _{GE} = 15 V (see Figure 16)		302 349 651		μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _t	Turn-ch รพ.tching losses Turn-of: switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_C = 30 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_C = 125 \text{ °C}$ <i>(see Figure 16)</i>		553 750 1303		μJ μJ μJ

Ecn is the turn-on losses when a typical diode is used in the test circuit in figure 2 Eon include diode recovery energy. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & diode are at the same temperature (25 °C and 125 °C)

2. Turn-off losses include also the tail of the collector current



105C

HV31690

 $V_{GE} = 15V$

lc=50A

lc=30A

150 TJ (°C)

lc=20A

50

100

Electrical characteristics (curves) 2.1

Figure 2. **Output characteristics**

Transfer characteristics Figure 3.

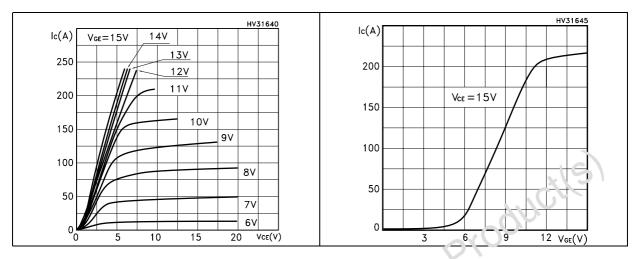




Figure 5.



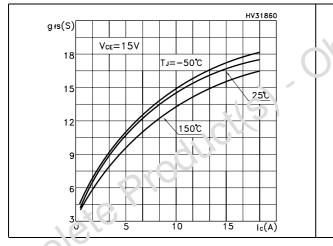
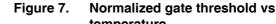


Figure S.

Collector-emitter on voltage vs collector current



-50

VCE(SAT)

2.6

2.4

2.2

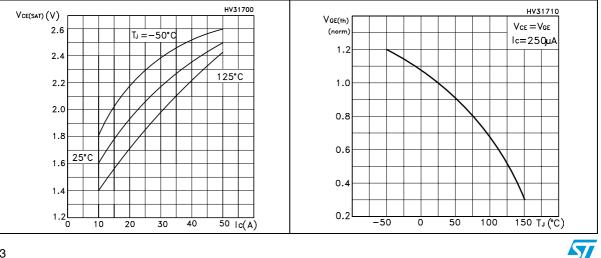
2.0

1.8

1.6

temperature

0



81 1.0 120Qg(nC)

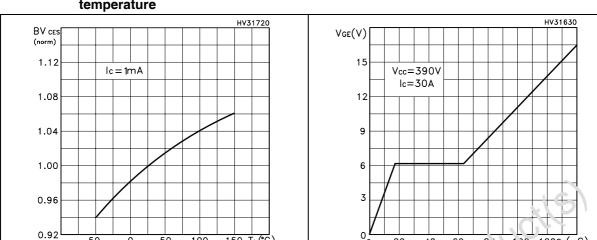
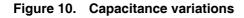


Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature



0

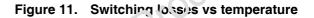
100

50

150 TJ (°C)

-50

5



60

40

20

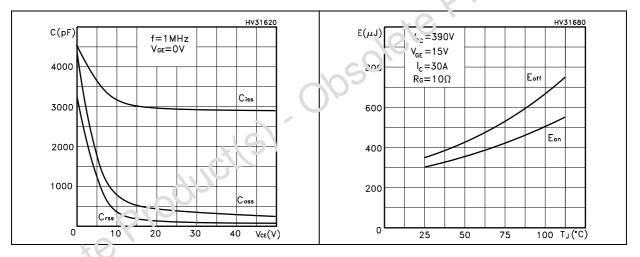
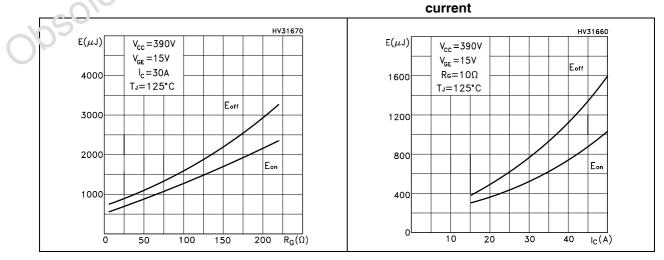


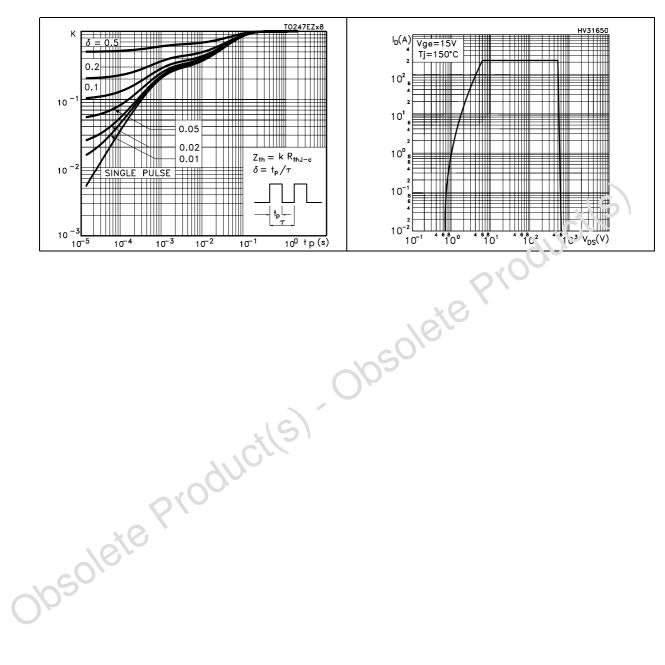
Figure 12 Switching losses vs gate resistance Figure 13. Switching losses vs collector



7/13

Figure 14. Thermal impedance

Figure 15. Turn-off SOA





3 Test circuit

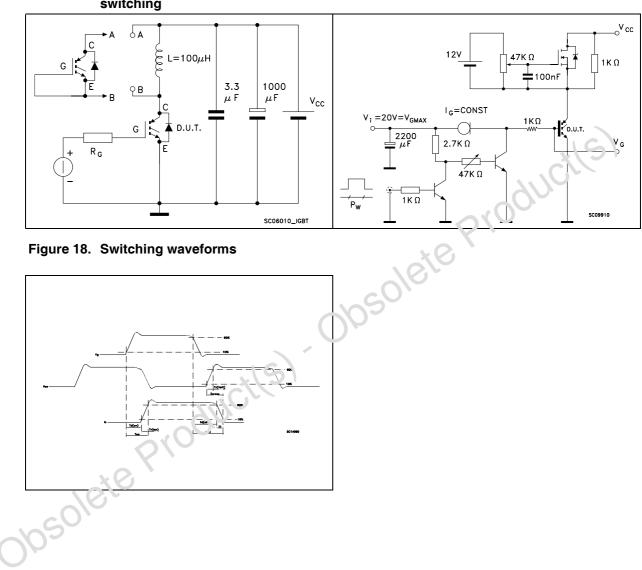


Figure 17. Gate charge test circuit

Figure 16. Test circuit for inductive load switching



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com*

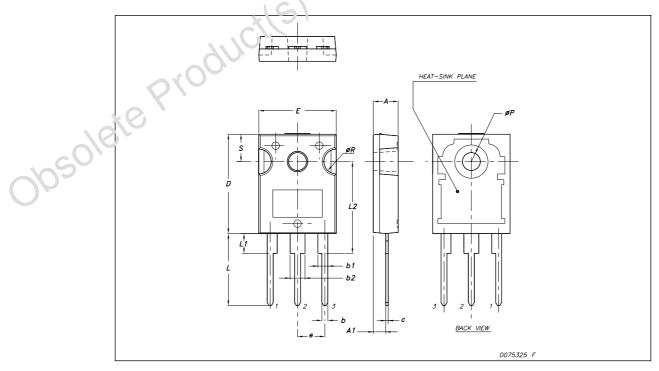
obsolete Produci(s) - Obsolete Produci(s)



57

Г

	TO-2	47 Mechanical data				
Dim.	mm.					
	Min.	Тур	Max.			
Α	4.85		5.15			
A1	2.20		2.60			
b	1.0		1.40			
b1	2.0		2.40			
b2	3.0		3.40			
с	0.40		0 c 0			
D	19.85		?ට.15			
E	15.45		15.75			
е		5.45				
L	14.20		14.80			
L1	3.70	1010	4.30			
L2		16.50				
øP	3.55	105	3.65			
øR	4.50	(D_{A})	5.50			
S	<hr/>	5.50				



5 Revision history

Table 8.Document revision history

Date	Revision	Changes
09-Jul-2008	1	First release

obsolete Product(s). Obsolete Product(s)

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